

Title (en)

A Method For Manufacturing a Part and Apparatus

Title (de)

Verfahren zur Herstellung eines Gegenstands und Vorrichtung

Title (fr)

procédé de fabrication d'un composant et dispositif

Publication

**EP 2224035 A1 20100901 (EN)**

Application

**EP 10153270 A 20100211**

Priority

US 36915709 A 20090211

Abstract (en)

A method and apparatus are present for manufacturing a part. The part is comprised of a metal alloy and is positioned to form a positioned part. An electromagnetic field is generated that heats the positioned part. A surface of the positioned part is exposed to an inert gas, while the electromagnetic field is generated to create an inverse thermal gradient between an exterior of the positioned part and an interior section of the positioned part to form a heat treated part.

IPC 8 full level

**H05B 6/40** (2006.01)

CPC (source: EP US)

**B21K 29/00** (2013.01 - EP US); **B23F 17/006** (2013.01 - EP US); **C21D 1/10** (2013.01 - EP US); **C21D 1/42** (2013.01 - EP US); **C21D 1/60** (2013.01 - EP US); **C21D 1/613** (2013.01 - EP US); **C21D 1/62** (2013.01 - EP US); **C21D 1/74** (2013.01 - EP US); **C21D 6/00** (2013.01 - EP US); **C21D 6/02** (2013.01 - EP US); **C21D 9/32** (2013.01 - EP US); **C21D 10/005** (2013.01 - EP US); **C22F 1/10** (2013.01 - EP US); **C22F 1/183** (2013.01 - EP US); **C23C 14/06** (2013.01 - EP US); **C21D 2211/004** (2013.01 - EP US); **Y02P 10/25** (2015.11 - EP US); **Y10T 29/4948** (2015.01 - EP US)

Citation (search report)

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Designated contracting state (EPC)

AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

Designated extension state (EPC)

AL BA RS

DOCDB simple family (publication)

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